

ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ\text{C}$, unless otherwise noted				
Parameter		Symbol	Limit	Unit
Reference to GND	V+		-0.3 to 5.0	V
	IN, COM, NC, NO ^a		-0.3 to (V+ + 0.3)	
Current (Any terminal except NO, NC or COM)			30	mA
Continuous Current (NO, NC, or COM)			± 300	
Peak Current (Pulsed at 1 ms, 10 % duty cycle)			± 500	
Storage Temperature (D Suffix)			-65 to 150	$^\circ\text{C}$
Package Solder Reflow Conditions ^d	16-Pin QFN (3 x 3 mm)		250	
Power Dissipation (Packages) ^b	QFN-16 ^c		1385	mW

Notes

a. Signals on NC, NO, or COM or IN exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.

b. All leads welded or soldered to PC Board.

c. Derate 17.3 mW/ $^\circ\text{C}$ above 70 $^\circ\text{C}$

d. Manual soldering with iron is not recommended for leadless components. The QFN is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper lip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

SPECIFICATIONS (V+ = 1.8 V)							
Parameter	Symbol	Test Condition Otherwise Unless Specified V+ = 1.8 V, VIN = 0.4 or 1.1 V ^e	Temp ^a	Limits −40 to 85°C			Unit
				Min ^b	Typ ^c	Max ^b	
Analog Switch							
Analog Signal Range ^d	VNO, VNC, VCOM		Full	0		V+	V
On-Resistance	rON	V+ = 1.8 V, VCOM = 0.2 V, INO, INC = 100 mA	Room		0.35	1.3	Ω
		V+ = 1.8 V, VCOM = 0.9 V, INO, INC = 100 mA			0.45		
			Full			1.4	
Digital Control							
Input High Voltage	VINH		Full	1.1			V
Input Low Voltage	VINL		Full			0.4	
Input Capacitance	Cin		Full		6		pF
Input Current	IINL or IINH	VIN = 0 or V+	Full	−1		1	μA
Dynamic Characteristics							
Turn-On Time	tON	VNO or VNC = 1.5 V, RL = 50 Ω, CL = 35 pF	Romm Full		62	94 97	ns
Turn-Off Time	tOFF		Room Full		24	52 55	
Break-Before-Make Time	td		Full	8			
Charge Injection ^d	QINJ	CL = 1 nF, VGEN = 0 V, RGEN = 0 Ω	Room		66		pC
Off-Isolation ^d	OIRR	RL = 50 Ω, CL = 5 pF, f = 100 kHz	Room		−74		dB
Crosstalk ^d	XTALK		Room		−74		
NO, NC Off Capacitance ^d	CNO(off)	VIN = 0 or V+, f = 1 MHz	Room		108		pF
	CNC(off)		Room		108		
Channel-On Capacitance ^d	CNO(on)		Room		240		
	CNC(on)		Room		240		
Power Supply							
Power Supply Current	I+	VIN = 0 or V+	Full			1.0	μA



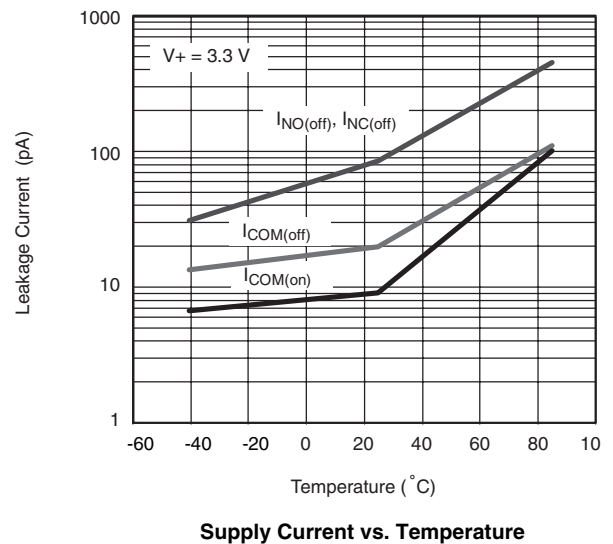
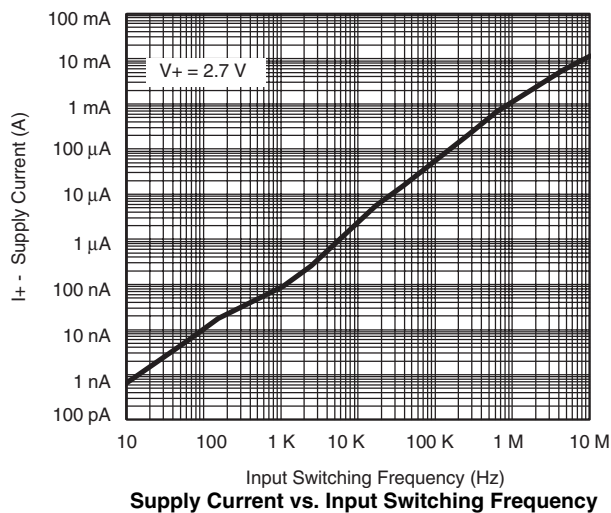
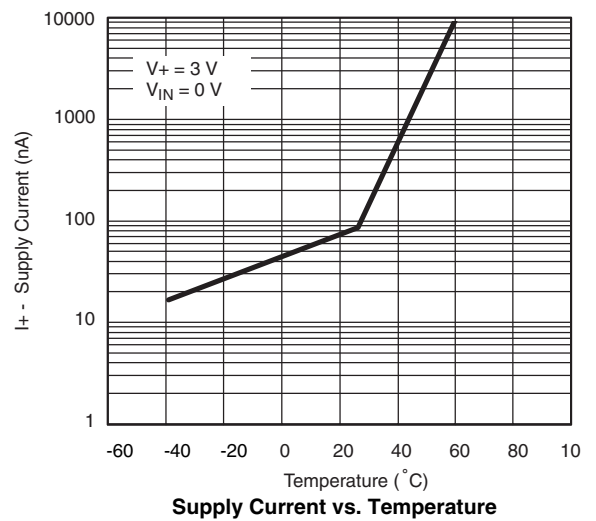
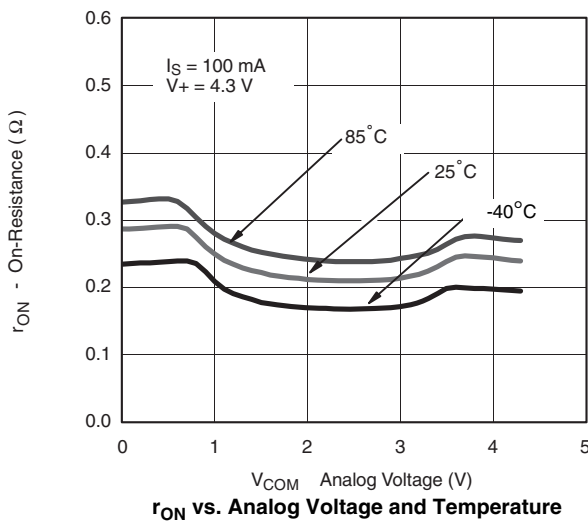
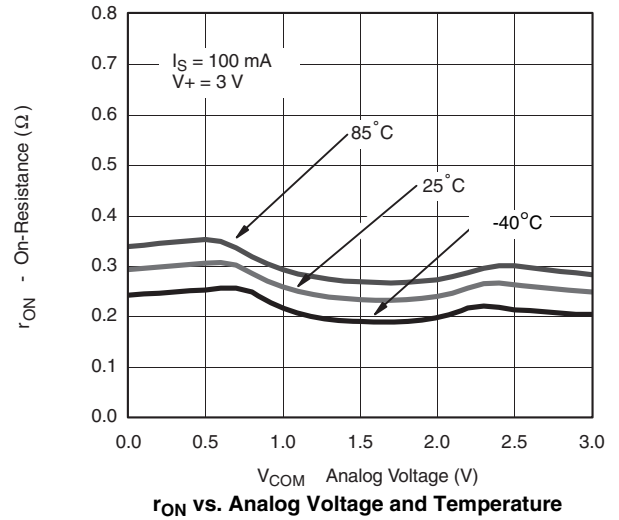
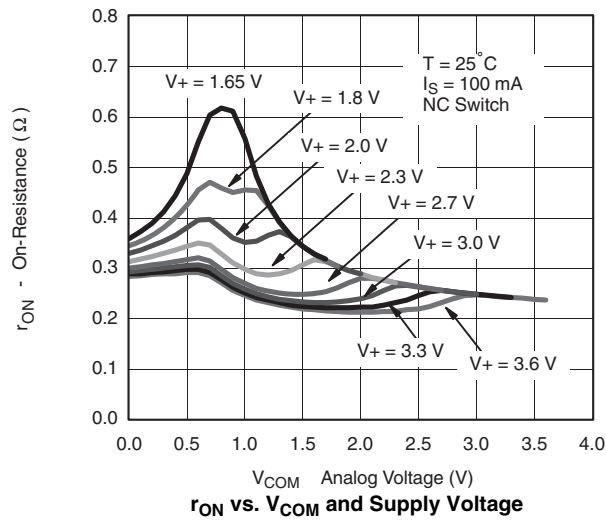
SPECIFICATIONS (V+ = 3 V)							
Parameter	Symbol	Test Condition Otherwise Unless Specified V+ = 3 V, ±10 %, VIN = 0.5 or 1.4 V ^e	Temp ^a	Limits –40 to 85°C			Unit
				Min ^b	Typ ^c	Max ^b	
Analog Switch							
Analog Signal Range ^d	V _{NO} , V _{NC} , V _{COM}		Full	0		V+	V
On-Resistance	r _{ON}	V+ = 2.7 V, V _{COM} = 0.2 V, I _{NO} , I _{NC} = 100 mA	Room		0.3	0.45	Ω
		V+ = 2.7 V, V _{COM} = 1.5 V, I _{NO} , I _{NC} = 100 mA			0.25		
			Full			0.55	
r _{ON} Flatness ^d	r _{ON} Flatness	V+ = 2.7 V, V _{COM} = 0 to V+, I _{NO} , I _{NC} = 100 mA	Room		0.07	0.15	
r _{ON} Match ^d	Δr _{ON}		Room		0.05		
Switch Off Leakage Current	I _{NO(off)} , I _{NC(off)F}	V+ = 3.3 V, V _{NO} , V _{NC} = 0.3 V / 3.0 V, V _{COM} = 3.0 V / 0.3 V	Room Full	–1 –10		1 10	nA
	I _{COM(off)}		Room Full	–1 –10		1 10	
Channel-On Leakage Current	I _{COM(on)}	V+ = 3.3 V, V _{NO} , V _{NC} = V _{COM} = 0.3 V / 3.0 V	Room Full	–1 –10		1 10	
Digital Control							
Input High Voltage	V _{INH}		Full	1.4			V
Input Low Voltage	V _{INL}		Full			0.5	
Input Capacitance	C _{in}		Full		6		pF
Input Current	I _{INL} or I _{INH}	V _{IN} = 0 or V+	Full	–1		1	μA
Dynamic Characteristics							
Turn-On Time	t _{ON}	V _{NO} or V _{NC} = 1.5 V, R _L = 50 Ω, C _L = 35 pF	Romm Full		28	57 60	ns
Turn-Off Time	t _{OFF}		Room Full		17	45 47	
Break-Before-Make Time	t _d		Full	1			
Charge Injection ^d	Q _{INJ}	C _L = 1 nF, V _{GEN} = 0 V, R _{GEN} = 0 Ω	Room		160		pC
Off-Isolation ^d	OIRR	R _L = 50 Ω, C _L = 5 pF, f = 100 kHz	Room		–75		dB
Crosstalk ^d	X _{TALK}		Room		–75		
N _O , N _C Off Capacitance ^d	C _{NO(off)}	VIN = 0 or V+, f = 1 MHz	Room		102		pF
	C _{NC(off)}		Room		102		
Channel-On Capacitance ^d	C _{NO(on)}		Room		234		
	C _{NC(on)}		Room		234		
Power Supply							
Power Supply Range	V+			2.7		3.3	V
Power Supply Current	I+	V _{IN} = 0 or V+	Full			1.0	μA

SPECIFICATIONS (V+ = 4.3 V)							
Parameter	Symbol	Test Condition Otherwise Unless Specified V+ = 4.3 V, VIN = 0.5 or 1.6 V ^e	Temp ^a	Limits –40 to 85°C			Unit
				Min ^b	Typ ^c	Max ^b	
Analog Switch							
Analog Signal Range ^d	VNO, VNC, VCOM		Full	0		V+	V
On-Resistance	rON	V+ = 4.3 V, VCOM = 0.5 V, INO, INC = 100 mA	Room		0.29	0.43	Ω
		V+ = 4.3 V, VCOM = 2.1 V, INO, INC = 100 mA		0.21			
			Full			0.53	
rON Flatness ^d	rON Flatness	V+ = 4.3 V, VCOM = 0 to V+, INO, INC = 100 mA	Room		0.07	0.15	
rON Match ^d	ΔrON		Room		0.05		
Switch Off Leakage Current ^d	INO(off), INC(off)	V+ = 4.3 V, VNO, VNC = 0.3 V / 4.0 V, VCOM = 4.0 V / 0.3 V	Room Full	–10 –100		10 100	nA
	ICOM(off)		Room Full	–10 –100		10 100	
Channel-On Leakage Current ^d	ICOM(on)	V+ = 4.3 V, VNO, VNC = VCOM = 3.0 V / 4.0 V	Room Full	–10 –100		10 100	
Digital Control							
Input High Voltage	VINH		Full	1.6			V
Input Low Voltage	VINL		Full			0.5	
Input Capacitance	Cin		Full		6		pF
Input Current	INL or INH	VIN = 0 or V+	Full	–1		1	μA
Dynamic Characteristics							
Charge Injection ^d	QINJ	CL = 1 nF, VGEN = 0 V, RGEN = 0 Ω	Room		320		pC
Off-Isolation ^d	OIRR	RL = 50 Ω, CL = 5 pF, f = 100 kHz	Room		–73		dB
Crosstalk ^d	XTALK		Room		–73		
NO, NC Off Capacitance ^d	CNO(off)	VIN = 0 or V+, f = 1 MHz	Room		100		pF
	CNC(off)		Room		100		
Channel-On Capacitance ^d	CNO(on)		Room		230		
	CNC(on)		Room		230		
Power Supply							
Power Supply Range	V+					4.3	V
Power Supply Current	I+	VIN = 0 or V+	Full			1.0	μA

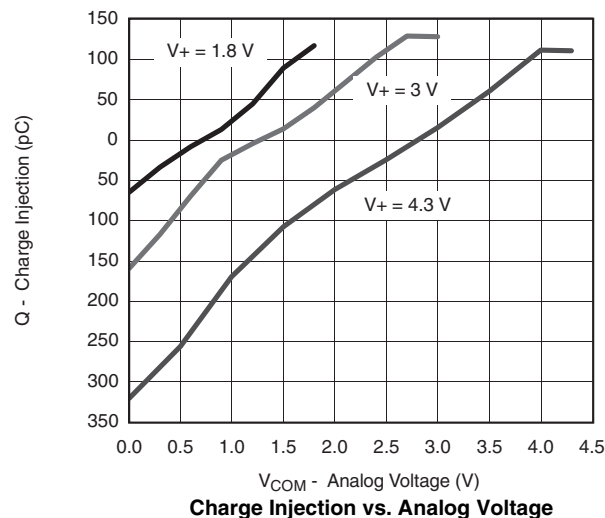
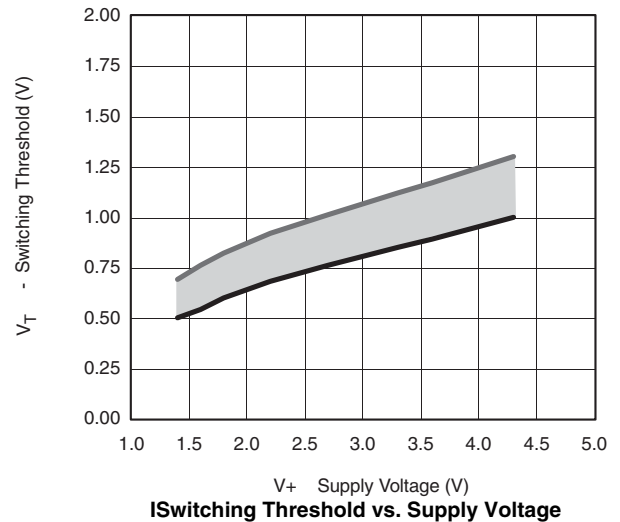
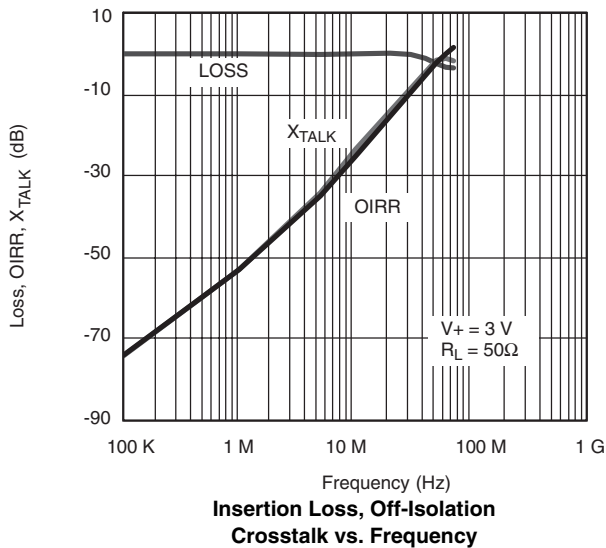
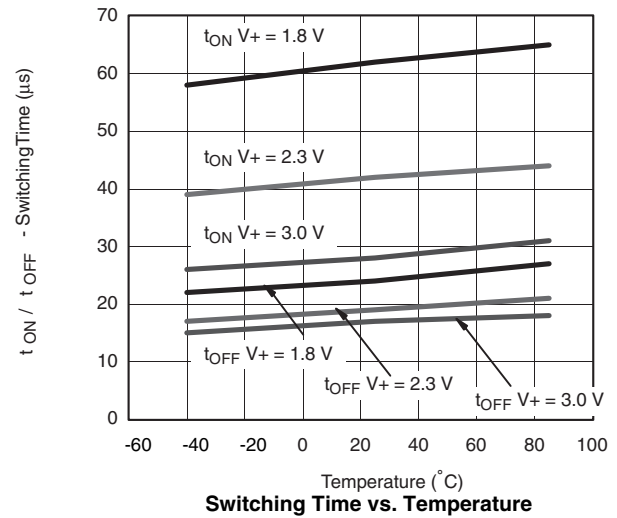
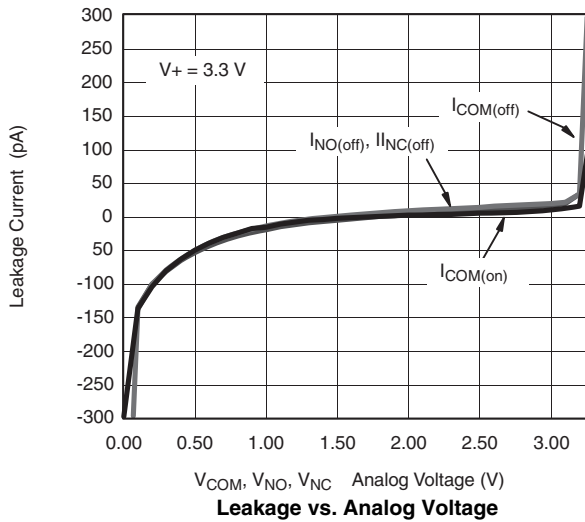
Notes

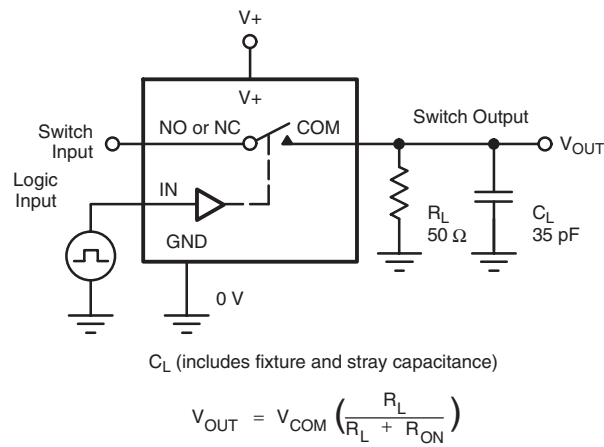
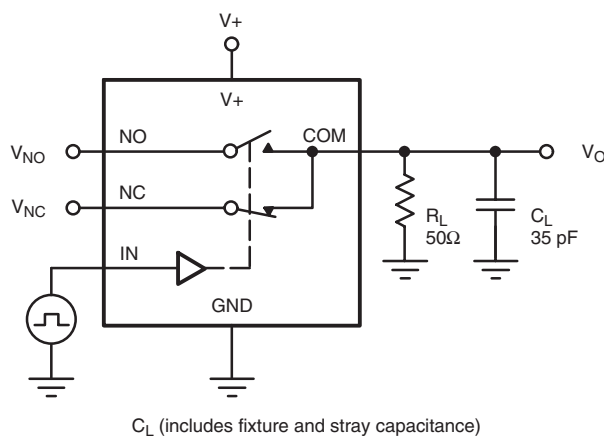
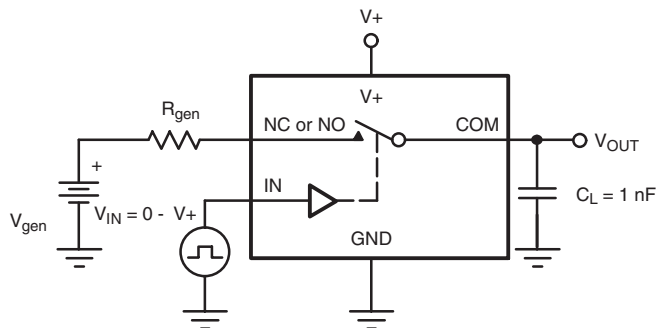
- a. Room = 25°C, Full = as determined by the operating suffix.
b. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
c. Typical values are for design aid only, not guaranteed nor subject to production testing.
d. Guarantee by design, not subjected to production test.
e. V_{IN} = input voltage to perform proper function.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS $T_A = 25^\circ\text{C}$, unless otherwise noted


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TEST CIRCUITS

Figure 1. Switching Time

Figure 2. Break-Before-Make Interval

Figure 3. Charge Injection

TEST CIRCUITS

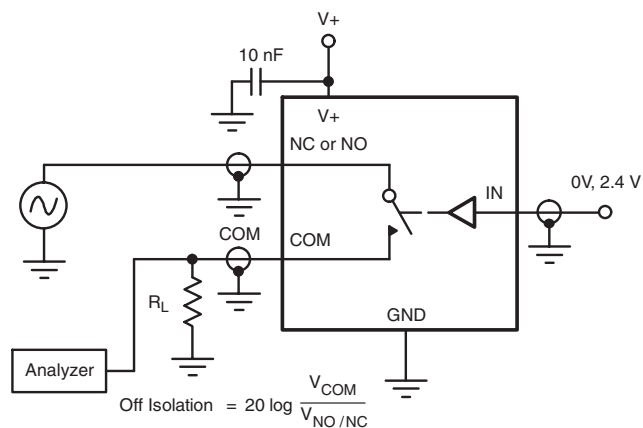


Figure 4. Off-Isolation

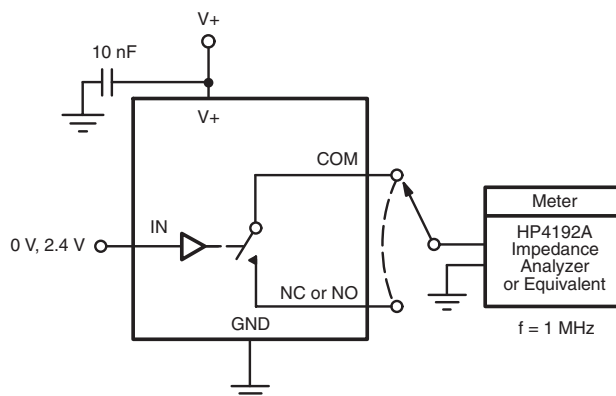


Figure 5. Channel Off/On Capacitance

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